

## Design of Microsystems (E030900)

Course size (nominal values; actual values may depend on programme)

Credits 6.0 Study time 180 h Contact hrs 60.0 h

Course offerings and teaching methods in academic year 2018-2019

A (semester 1)	Dutch	project	30.0 h
		lecture	30.0 h

Lecturers in academic year 2018-2019

Doutrelaigne, Jan	TW06	lecturer-in-charge
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Offered in the following programmes in 2018-2019

	crdts	offering
<a href="#">Master of Science in Electrical Engineering (main subject Electronic Circuits and Systems)</a>	6	A
<a href="#">Master of Science in Biomedical Engineering</a>	6	A
<a href="#">International Master of Science in Biomedical Engineering</a>	6	A
<a href="#">Master of Science in Biomedical Engineering</a>	6	A
<a href="#">Master of Science in Electrical Engineering</a>	6	A

Teaching languages

Dutch

Keywords

microsystems, intelligent interfaces, smart power technology, System on Chip (SoC), System in Package (SiP), System on Board (SoB), Multi Chip Module (MCM), IC design

Position of the course

To provide insight in the structure and operation of a microsystem.  
To teach methodologies to design a complete microsystem step by step from the system level down to the physical layout level.  
Training in the field of microsystem design by means of practical projects.

Contents

- Structure of a microsystem: Block diagram, Sensors, Actuators, Signal conditioning, AD and DA converters, Data processing unit, Output drivers
- Microsystem design methodologies: Selection of the implementation type, Selection of the integration technology, Design of integrated intelligent interfaces, "System on Chip" (SoC) design, Projects
- Appendix: Applications and data sheets

Initial competences

Design of analog circuits and building blocks, VLSI technology and design

Final competences

- 1 Analyse the operation of building blocks in microsystems
- 2 Understand the structure and properties of the main building blocks in a modern microsystem
- 3 Design and dimension a complex microsystem in an advanced smart-power IC technology on the basis of imposed specifications

Conditions for credit contract

Access to this course unit via a credit contract is determined after successful competences assessment

Conditions for exam contract

This course unit cannot be taken via an exam contract

#### Teaching methods

Lecture, project

#### Extra information on the teaching methods

Classroom lectures; Projects

#### Learning materials and price

Extensive set of English PowerPoint slides. Limited syllabus.

#### References

#### Course content-related study coaching

Continuous guidance/support, for the theoretical classes as well as for the design project, during the whole semester by the responsible professor and a scientific coworker.

#### Evaluation methods

end-of-term evaluation and continuous assessment

#### Examination methods in case of periodic evaluation during the first examination period

Written examination

#### Examination methods in case of periodic evaluation during the second examination period

Written examination

#### Examination methods in case of permanent evaluation

Report

#### Possibilities of retake in case of permanent evaluation

examination during the second examination period is possible in modified form

#### Extra information on the examination methods

During examination period: written open-book exam

During semester: graded project reports. Second chance: Possible in adapted form

Frequency: The student must do 1 big design project (in group) that takes about one month and a half.

#### Calculation of the examination mark

Evaluation throughout semester as well as during examination period. Special conditions: Non-periodic evaluation: 40% Periodic evaluation: 60%